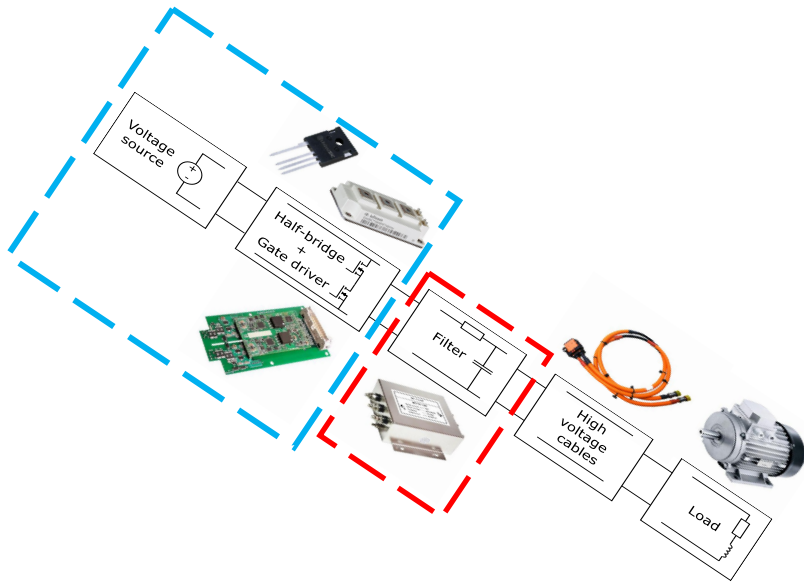


Double pulse testing

Philip Abrahamsson

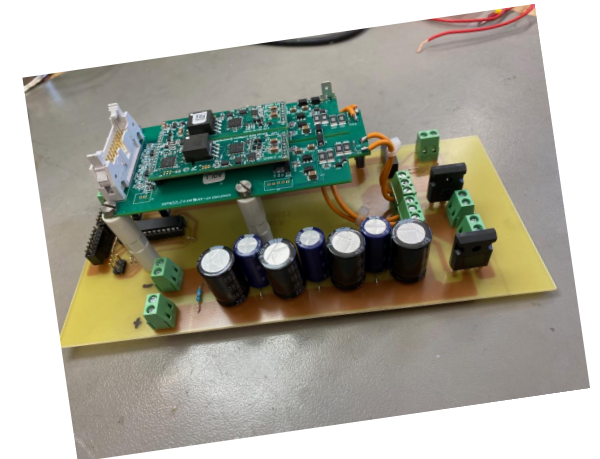


IMZ120R140M1H
CoolSiC™ 1200V SiC Trench MOSFET
Electrical Characteristics

3.3 Switching characteristics

Table 6 Switching characteristics, inductive load⁺

Parameter	Symbol	Conditions	Value			Unit
			min.	typ.	max.	
MOSFET Characteristics, T_c = 25°C						
Turn-on delay time	t _{delay}	V _{GS} = 800V, I _D = 6A,	-	5	-	ns
Rise time	t _r	V _{GS} = 0/18V, R _{GS} = 2Ω,	-	2	-	
Turn-off delay time	t _{fall}	L _D = 40nH,	-	10.3	-	
Fall time	t _f	diode:	-	11.6	-	
Turn-on energy	E _{on}	body diode at V _{GS} = 0V	-	62	-	
Turn-off energy	E _{off}	see Fig. E	-	12	-	μJ
Total switching energy	E _{sw}		-	74	-	
Body Diode Characteristics, T_c = 25°C						
Diode reverse recovery charge	Q _r	V _{GS} = 800V, I _D = 6A, V _{GS} at diode = 0V, di/dt = 1000A/μs, Q _r includes also Q _s , see Fig. C	-	100	-	nC
Diode peak reverse recovery current	I _{rrm}		-	2	-	A



Other applications

Power Transistor



- It takes some time for the current and voltage to fall/rise
- Losses are generated during a switching event

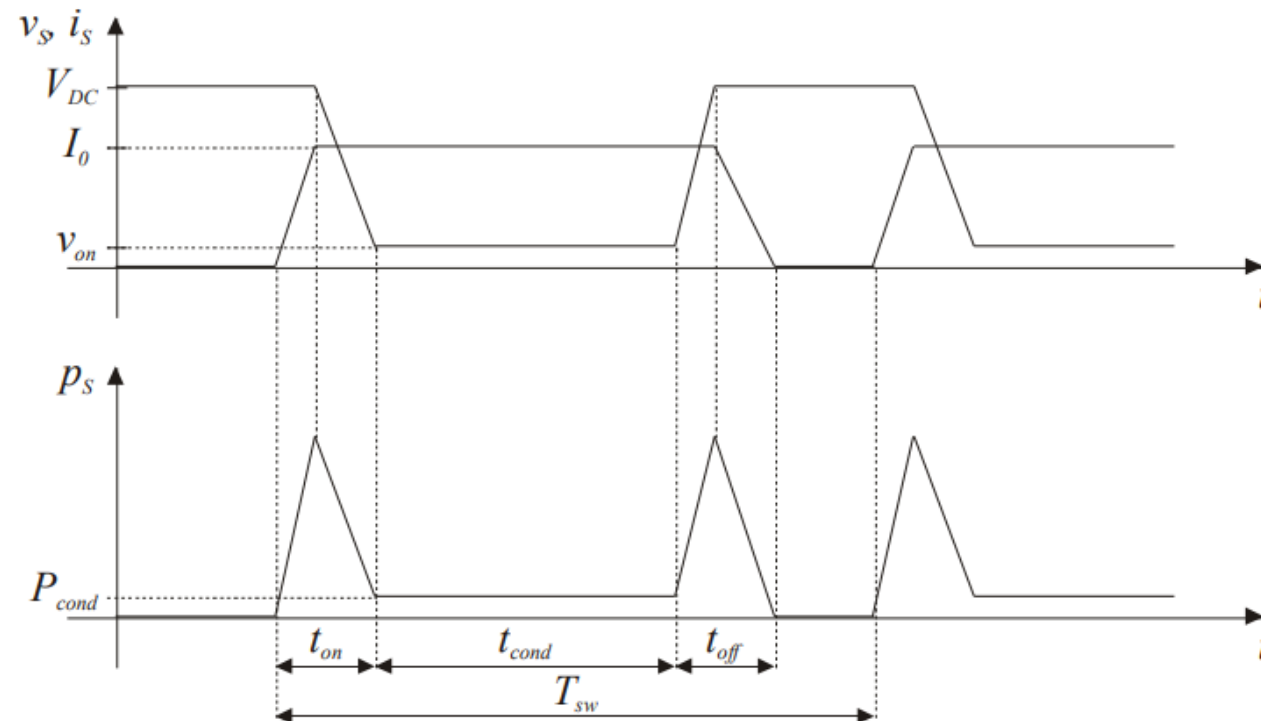


Figure 6.2: Approximate switching waveforms for the switch S .

Measure switching characteristics

- Measure current and voltage during turn on and off events.
- Double pulse testing



IMZ120R140M1H

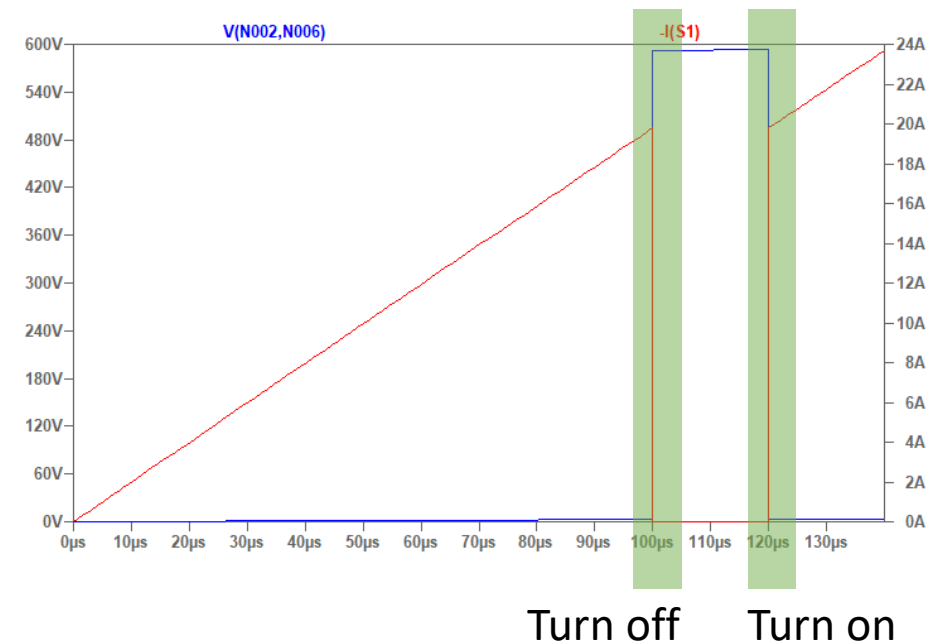
CoolSiC™ 1200V SiC Trench MOSFET

Electrical Characteristics

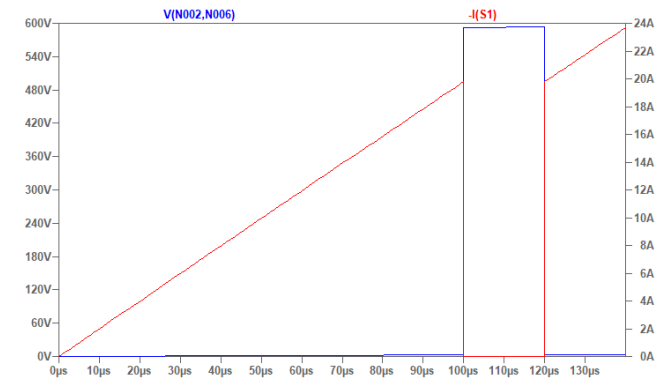
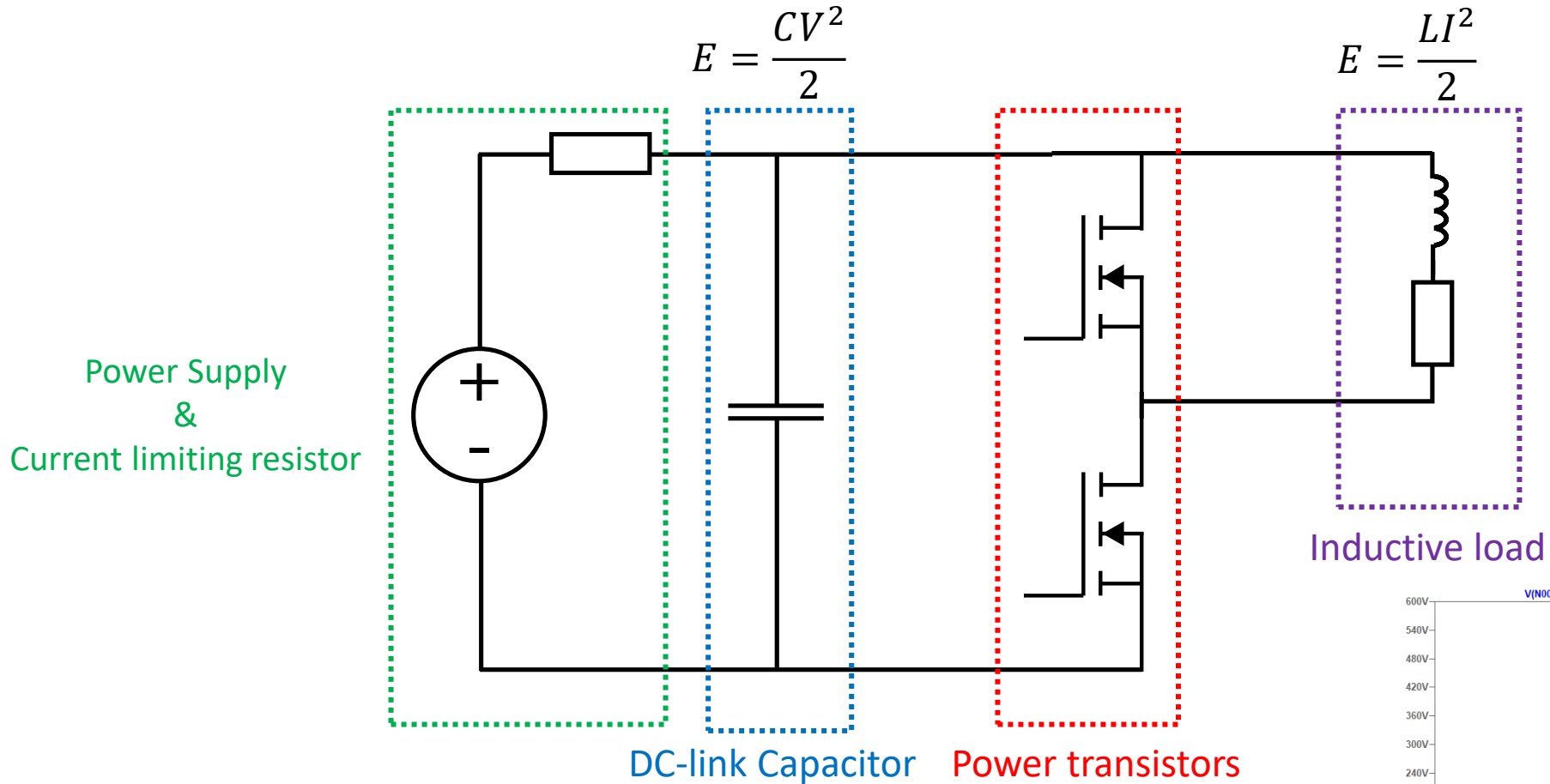
3.3 Switching characteristics

Table 6 Switching characteristics, Inductive load ⁴

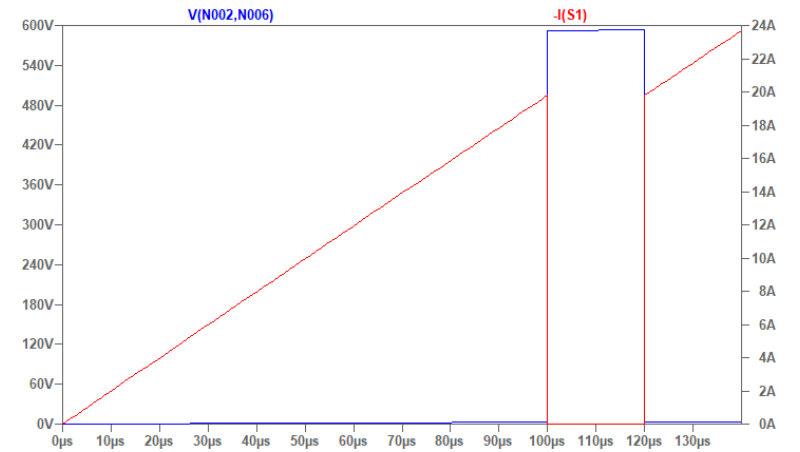
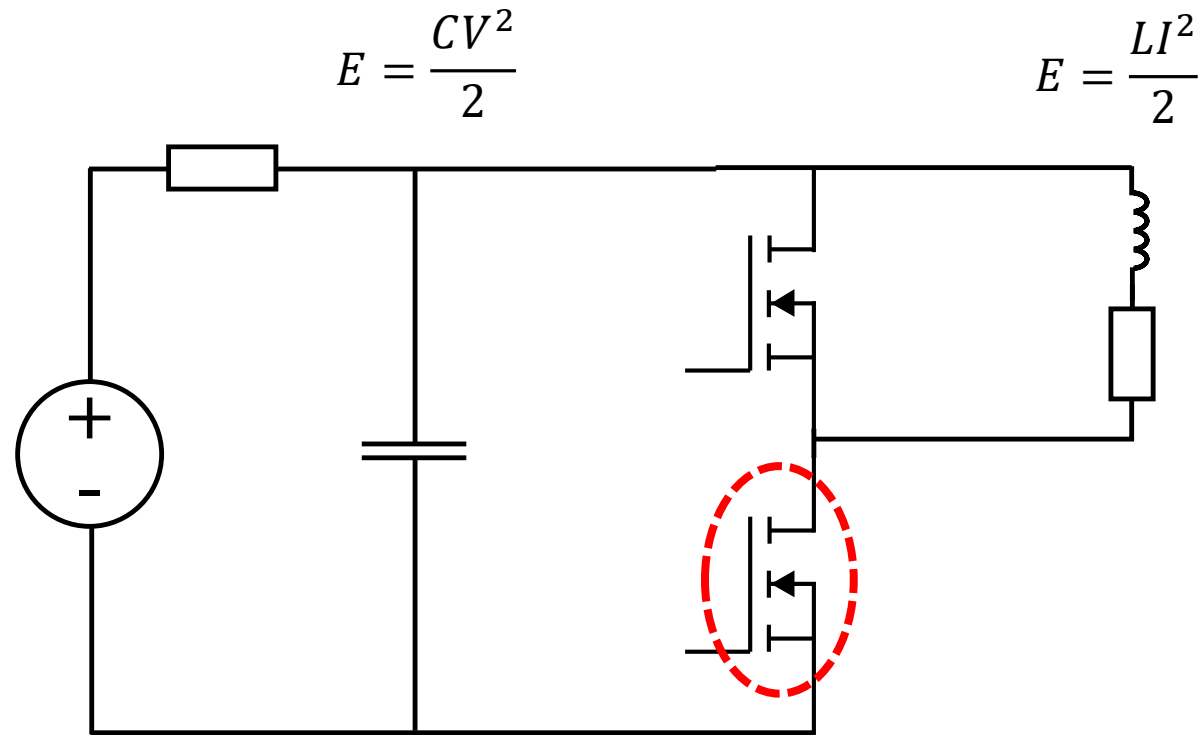
Parameter	Symbol	Conditions	Value			Unit
			min.	typ.	max.	
MOSFET Characteristics, $T_{vj} = 25^{\circ}\text{C}$						
Turn-on delay time	$t_{d(on)}$	$V_{DD} = 800\text{V}$, $I_D = 6\text{A}$, $V_{GS} = 0/18\text{V}$, $R_{G,ext} = 2\Omega$, $L_{\sigma} = 40\text{nH}$, diode: body diode at $V_{GS} = 0\text{V}$ see Fig. E	-	5	-	ns
Rise time	t_r		-	2	-	
Turn-off delay time	$t_{d(off)}$		-	10.3	-	
Fall time	t_f		-	11.6	-	
Turn-on energy	E_{on}		-	62	-	μJ
Turn-off energy	E_{off}	-	12	-		
Total switching energy	E_{tot}	-	74	-		
Body Diode Characteristics, $T_{vj} = 25^{\circ}\text{C}$						
Diode reverse recovery charge	Q_{rr}	$V_{DD} = 800\text{V}$, $I_{SD} = 6\text{A}$, V_{GS} at diode = 0V , $di/dt = 1000\text{A}/\mu\text{s}$, Q_{rr} includes also Q_C , see Fig. C	-	100	-	nC
Diode peak reverse recovery current	I_{rrm}		-	2	-	A



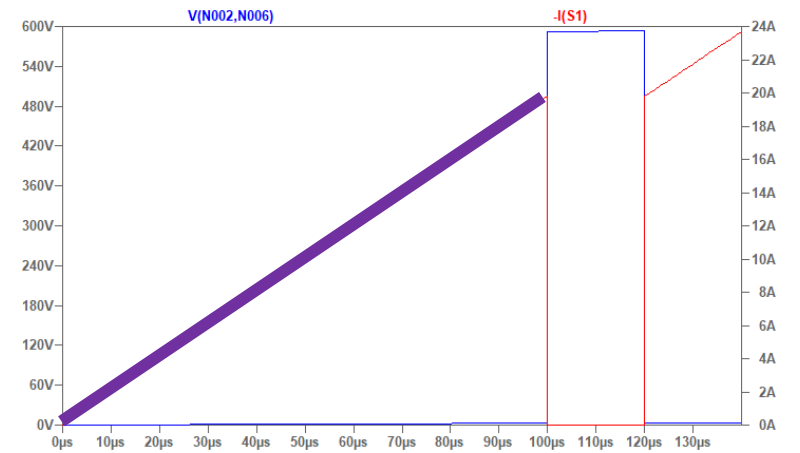
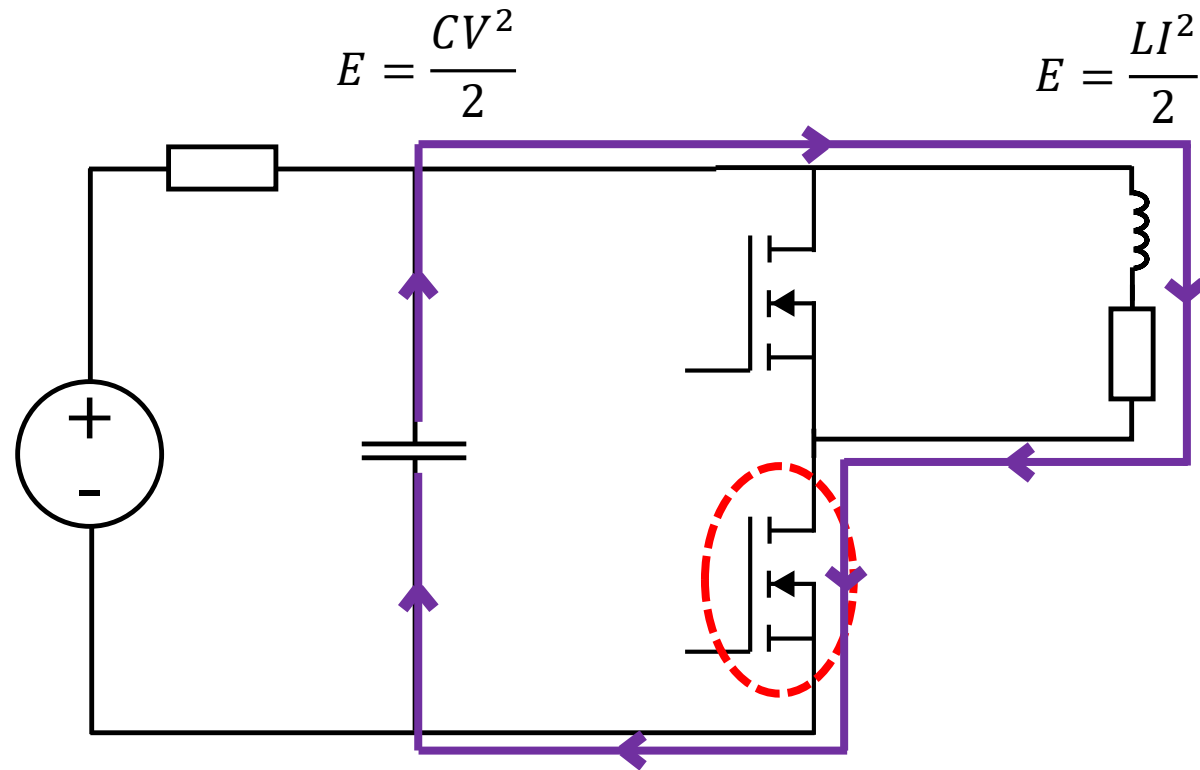
Double pulse tester – The different parts



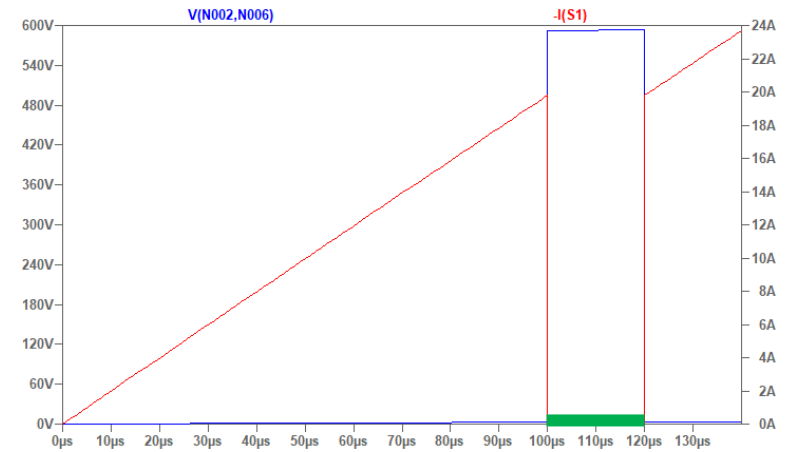
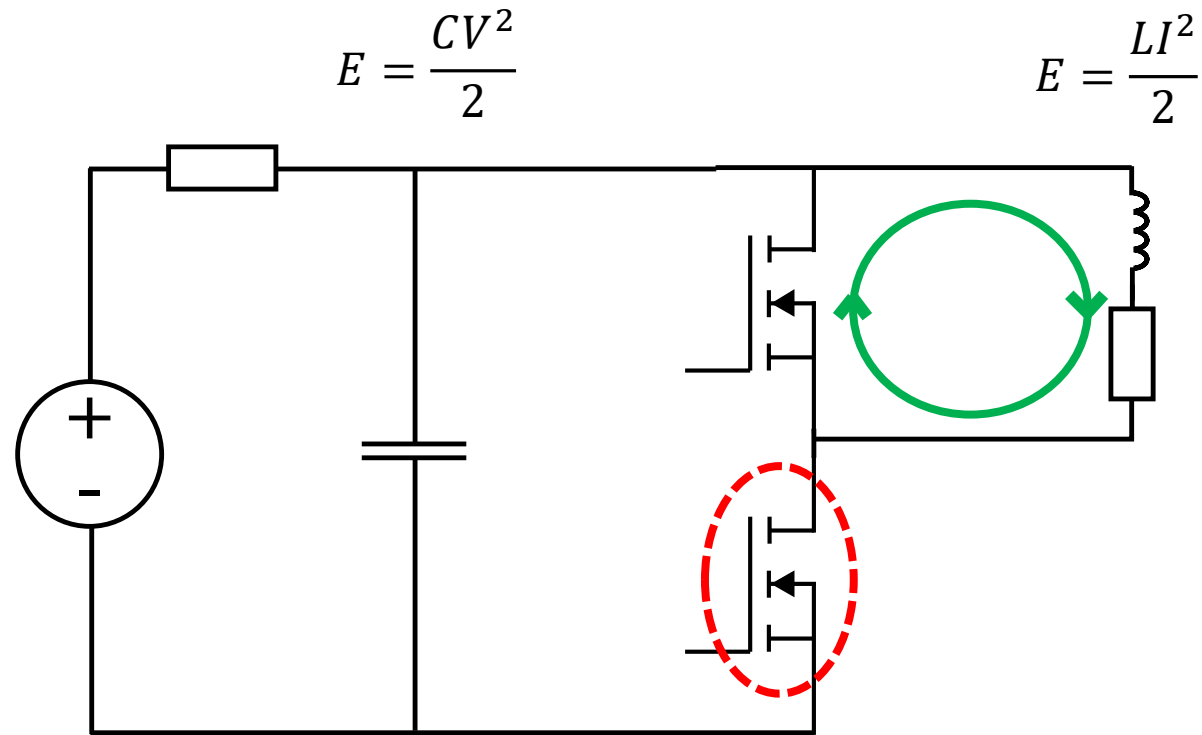
Double pulse tester – How it works



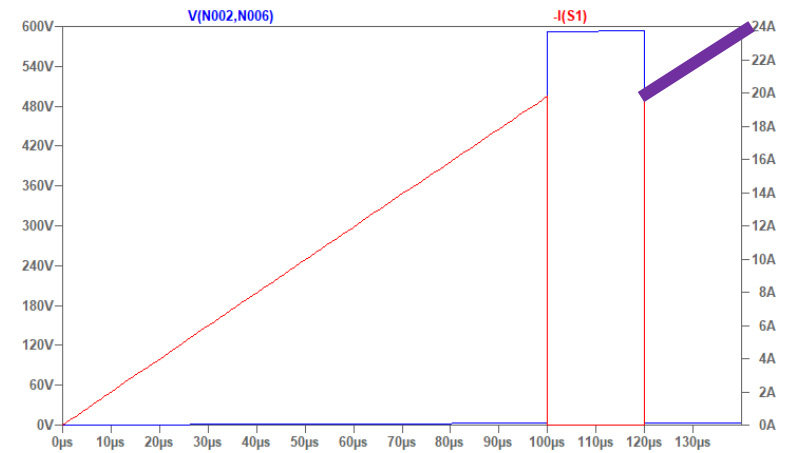
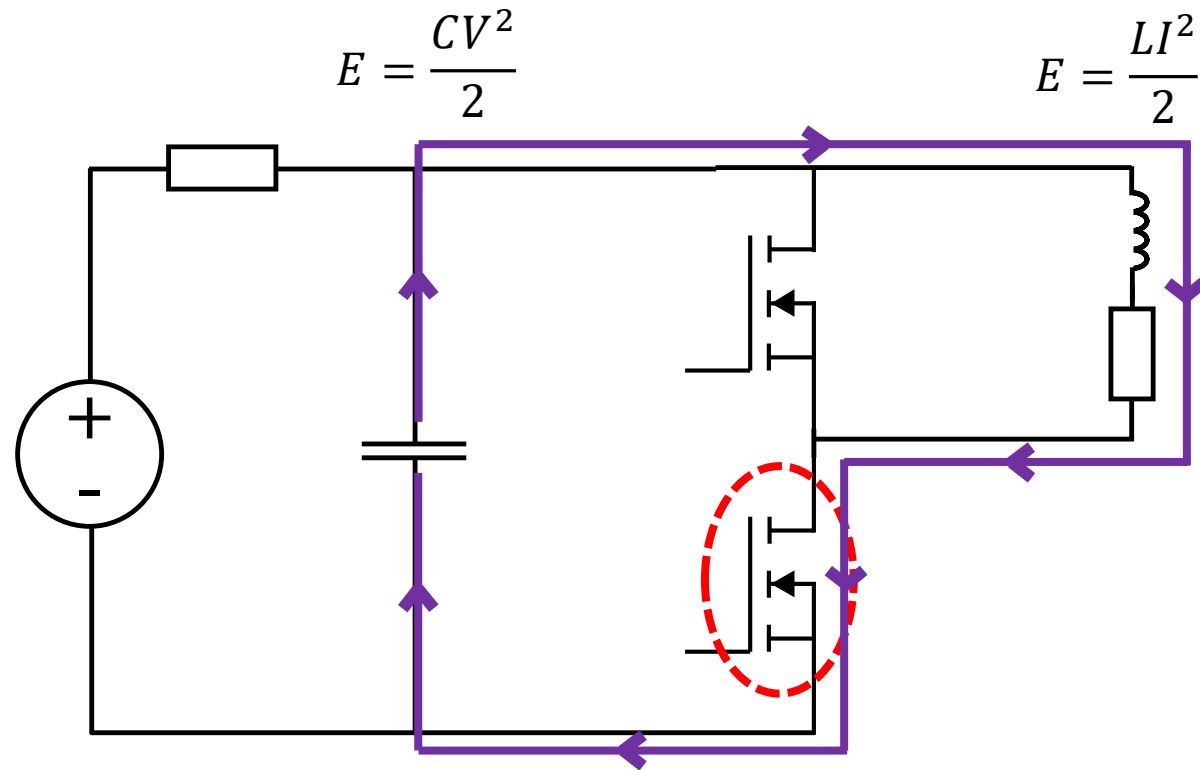
Double pulse tester – How it works



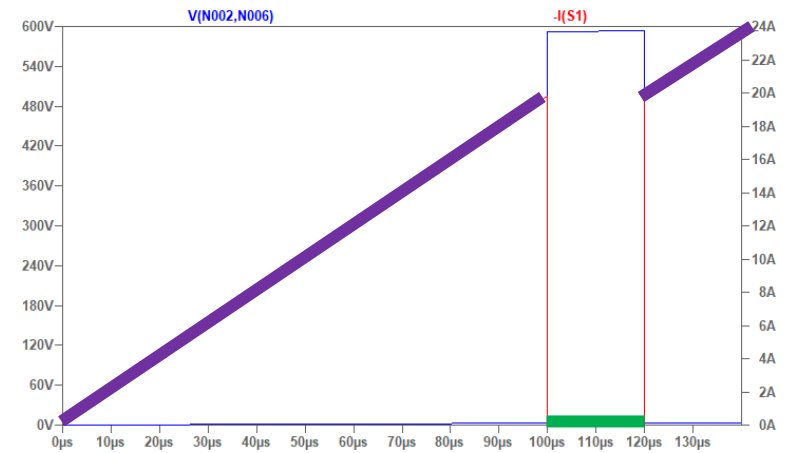
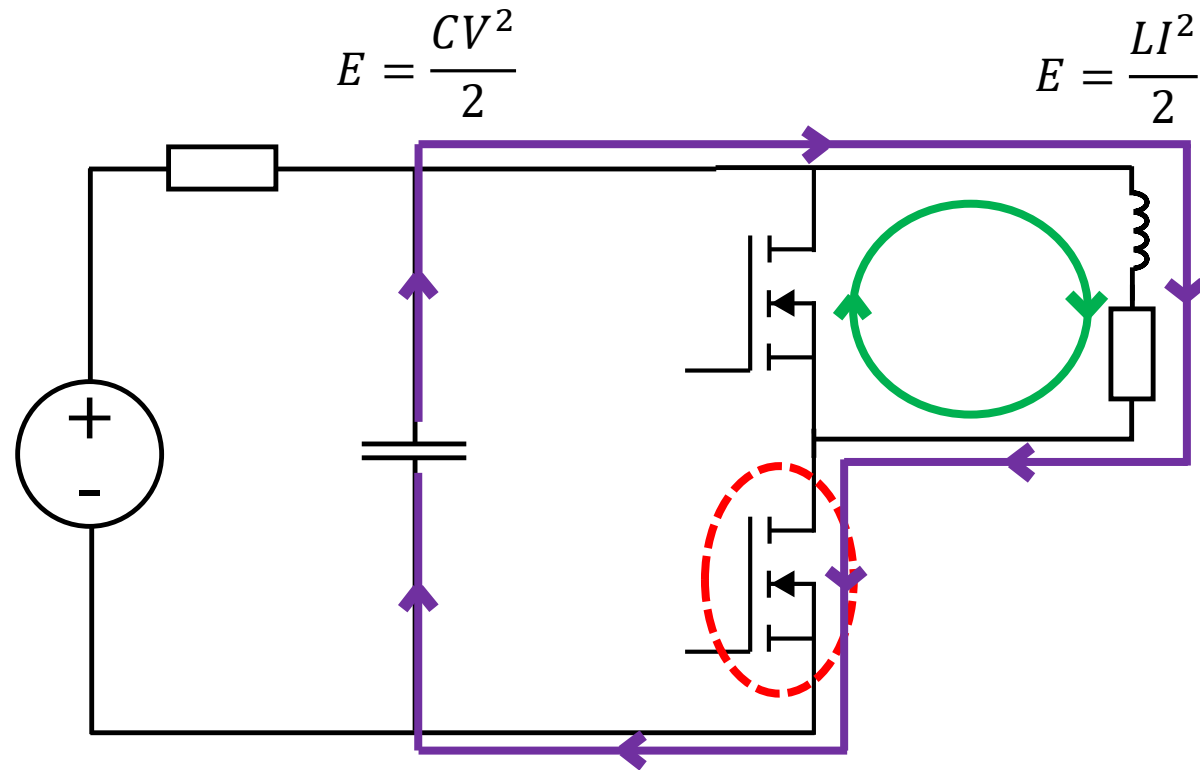
Double pulse tester – How it works



Double pulse tester – How it works

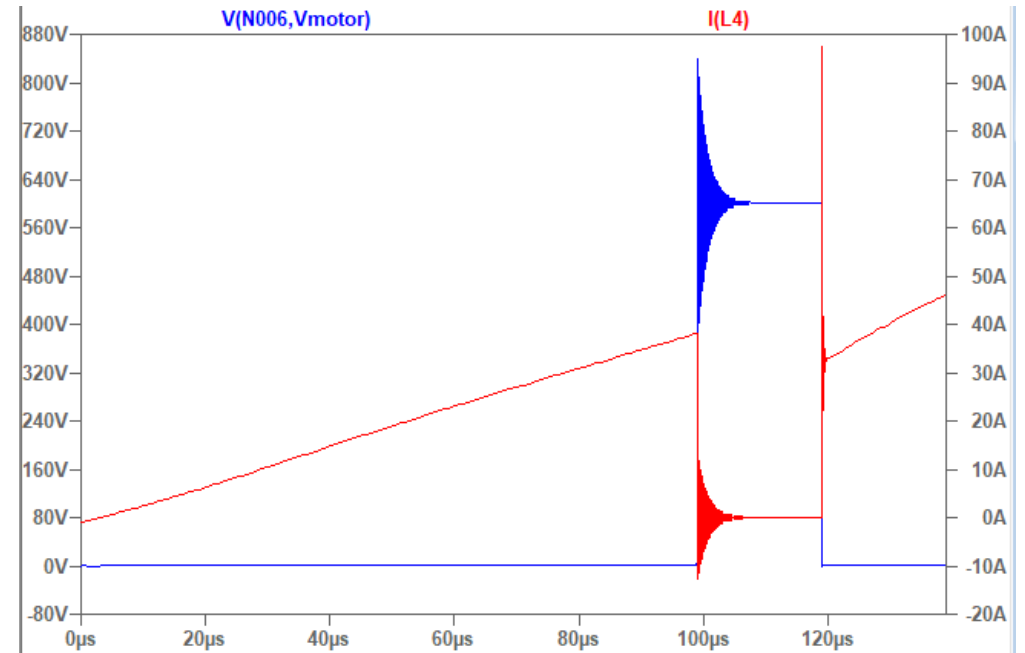
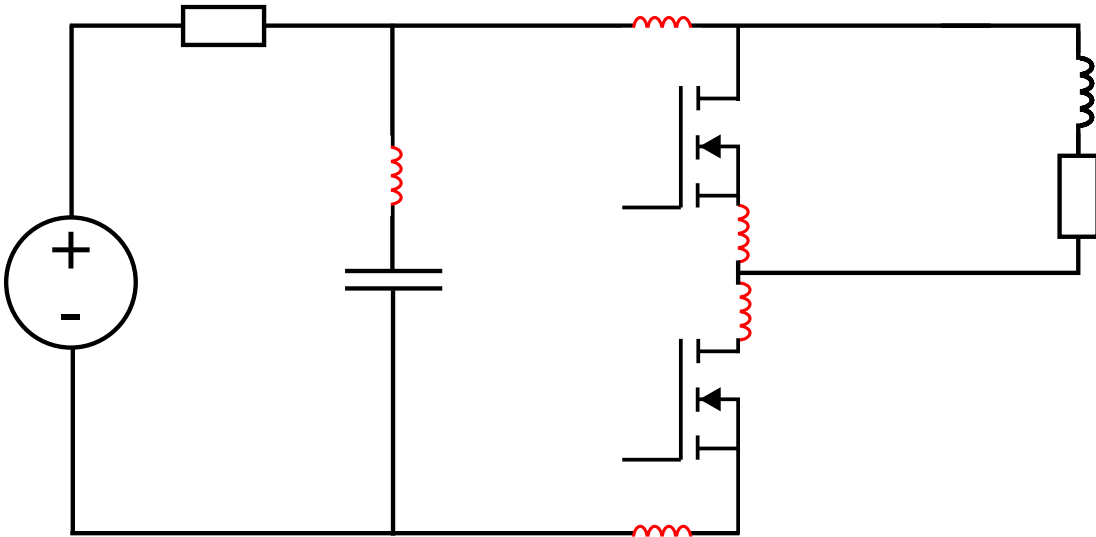


Double pulse tester – How it works



Double pulse tester – Parasitics

- Parasitics are present in any real circuit
- Non ideal switching events



PCB design

- A good PCB design can reduce stray inductance

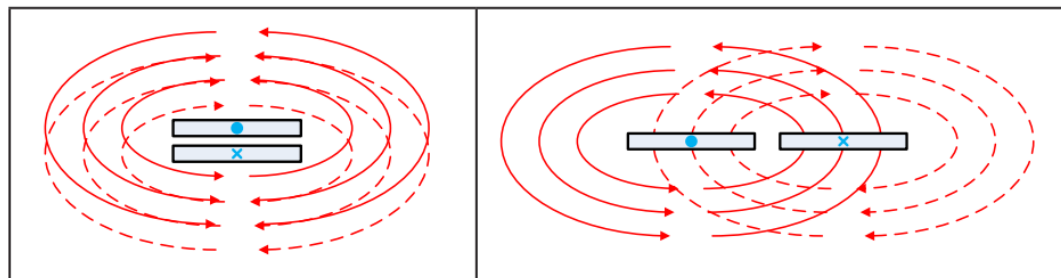
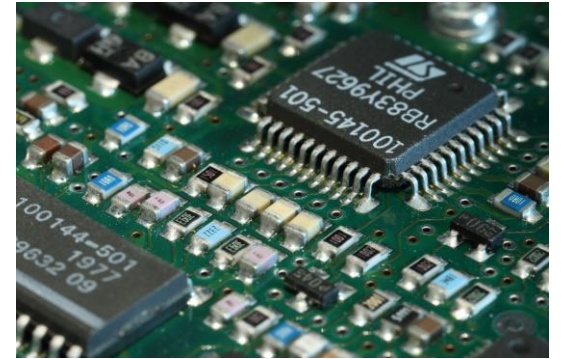
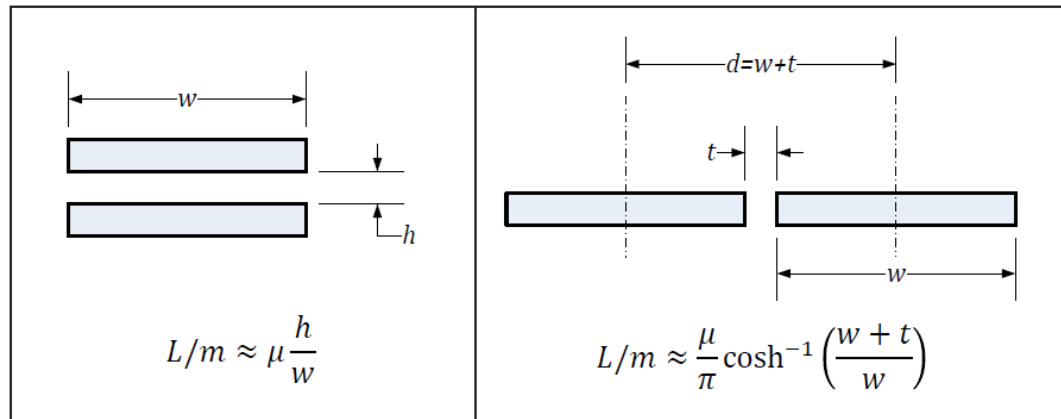


Figure 6: Parallel plate overlap

Figure 7: Coplanar plate overlap

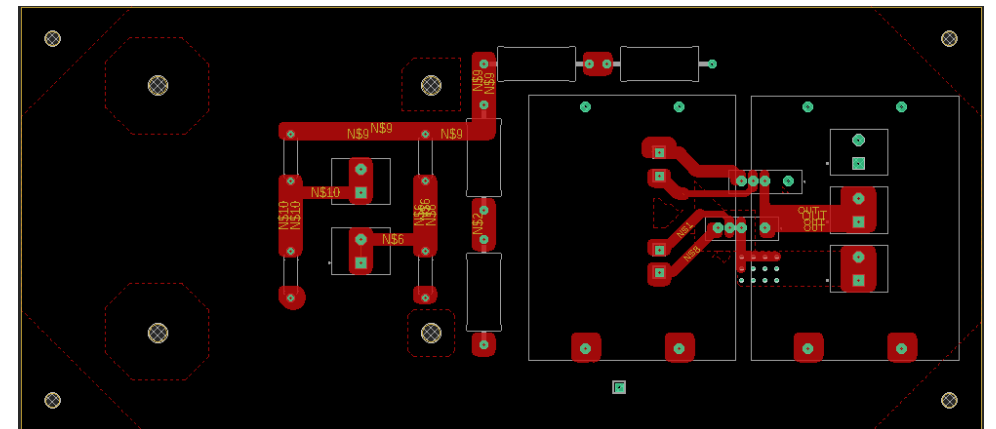
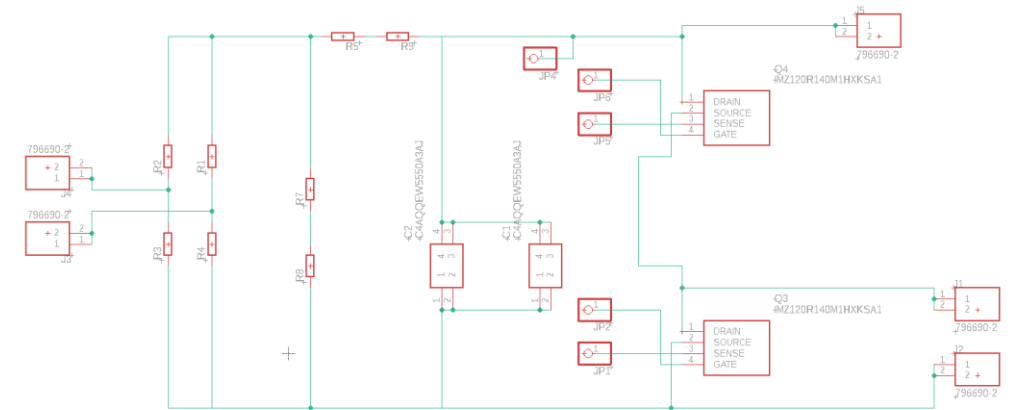


$$L/m \approx \mu \frac{h}{w}$$

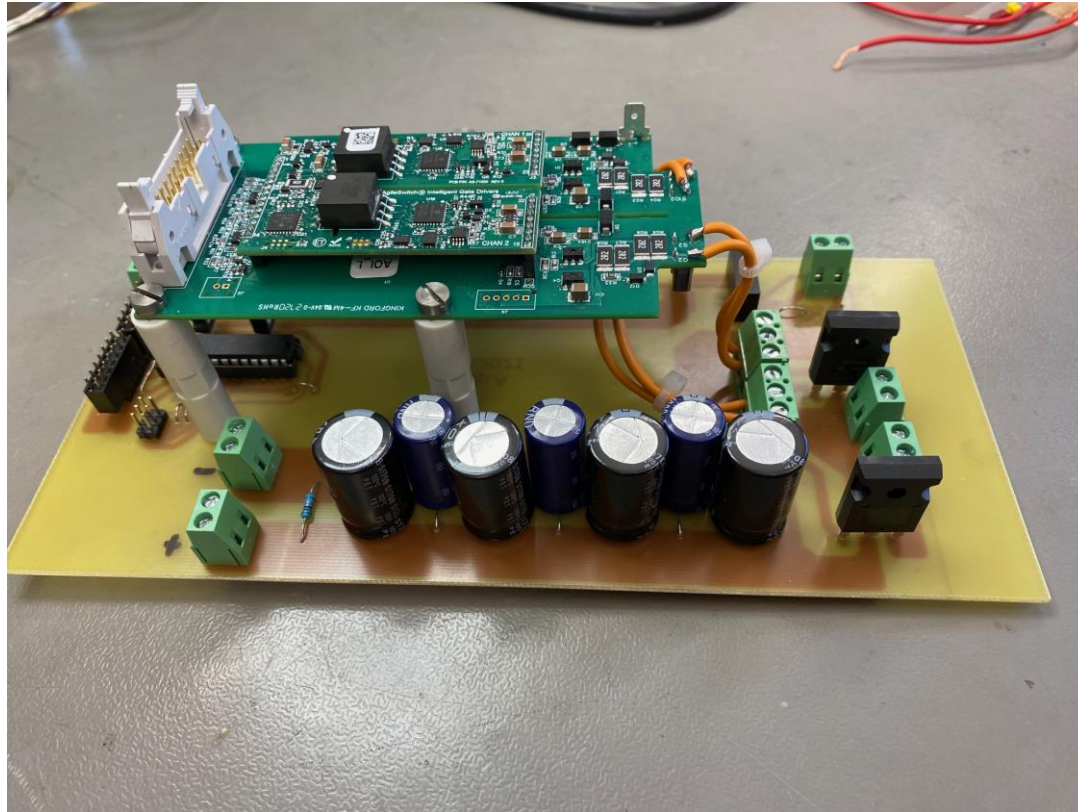
$$L/m \approx \frac{\mu}{\pi} \cosh^{-1} \left(\frac{w+t}{w} \right)$$

Figure 8: Parallel plate inductance approximation

Figure 9: Coplanar plate inductance approximation



Results - PCB

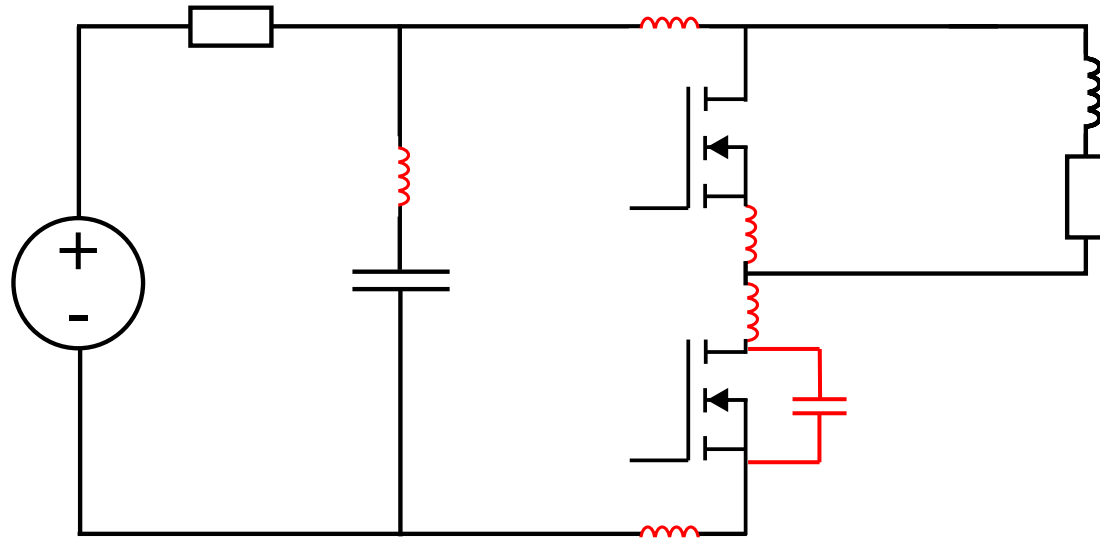


Results

- Video from the lab

Results

- Ringing is also caused by capacitance in the circuit



Results - Measurements

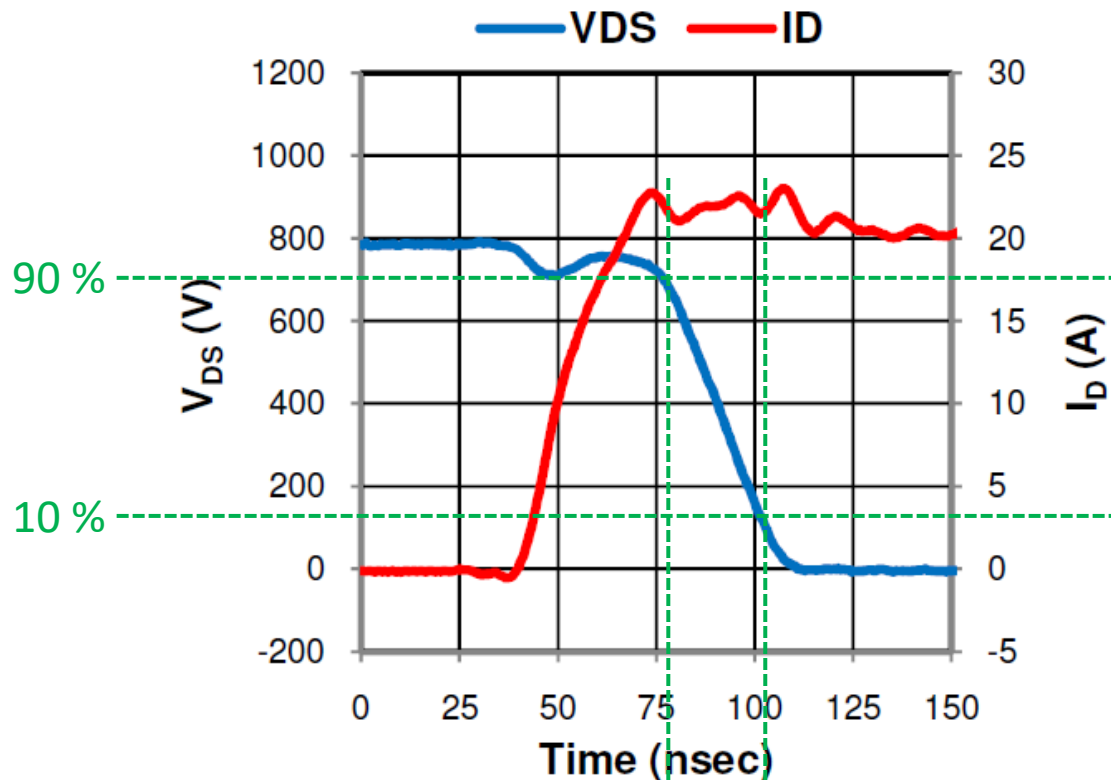


Figure 9: Turn-On Waveforms

Rise time

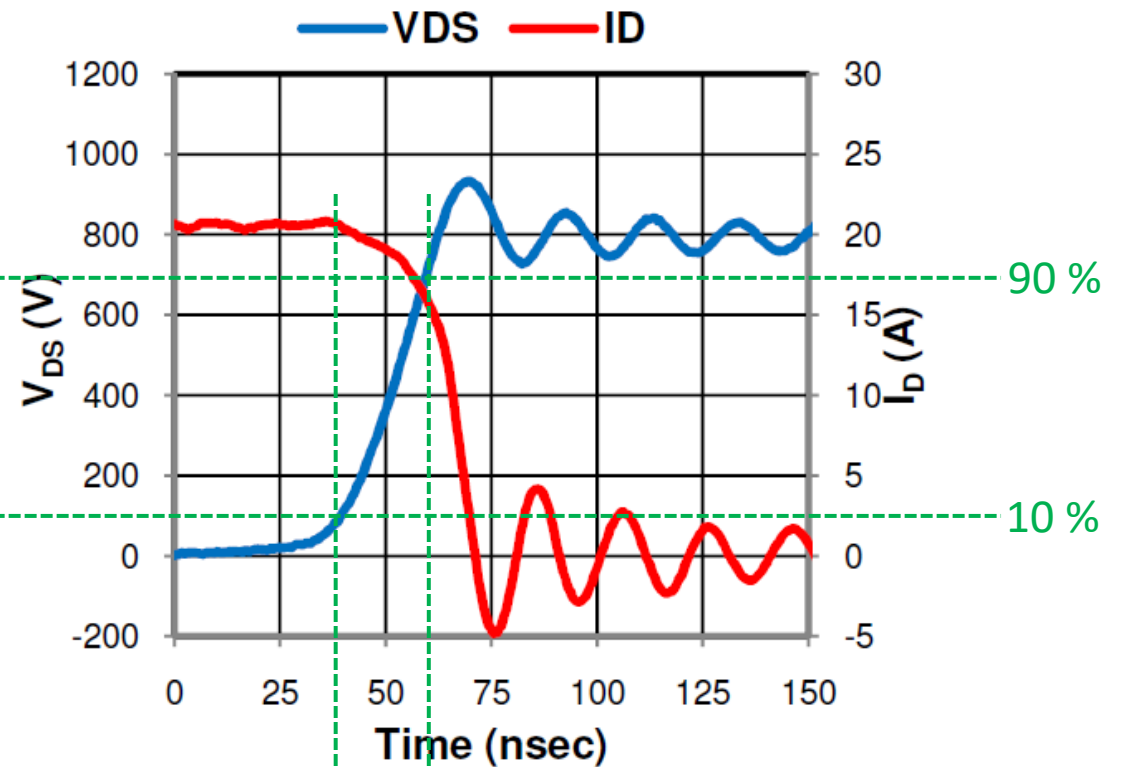
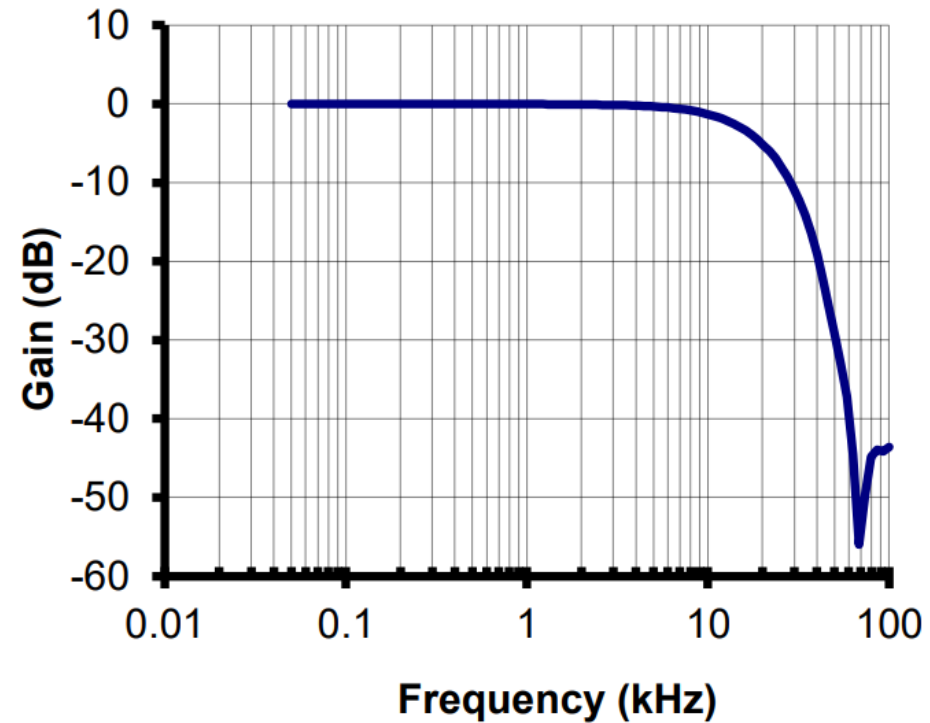


Figure 10: Turn-Off Waveforms

Fall time

Measurement equipment - Properties

- Bandwidth
- Delay
- Accuracy

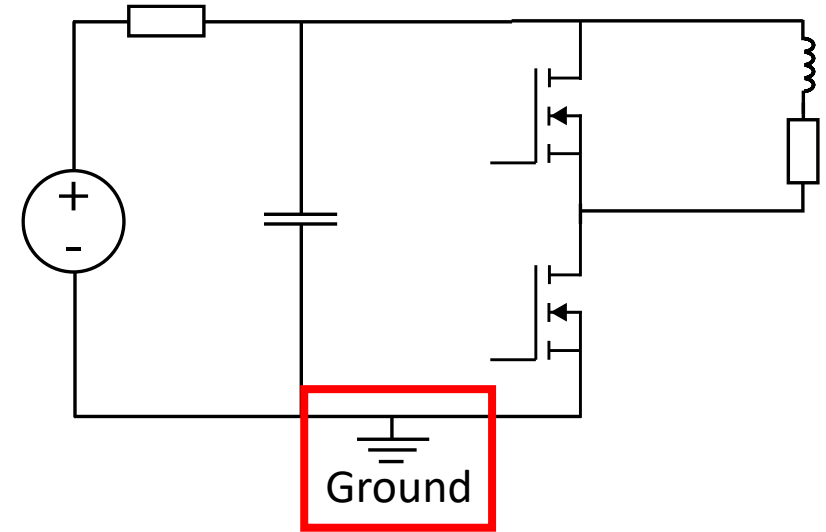


Measurement equipment – Examples of probes

Single ended



Differential



Measurement equipment – Examples of probes

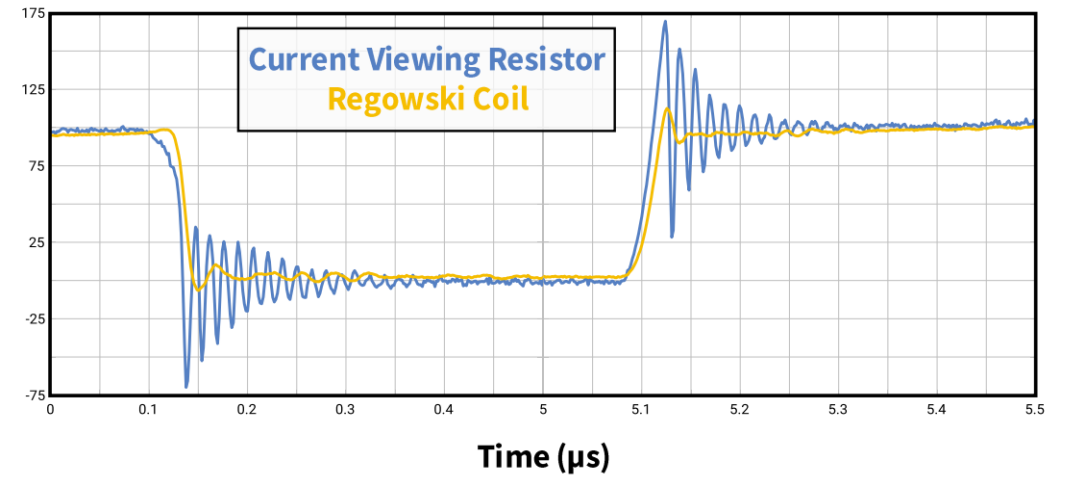
Resistor



Rogowski coil



Source Current (A)



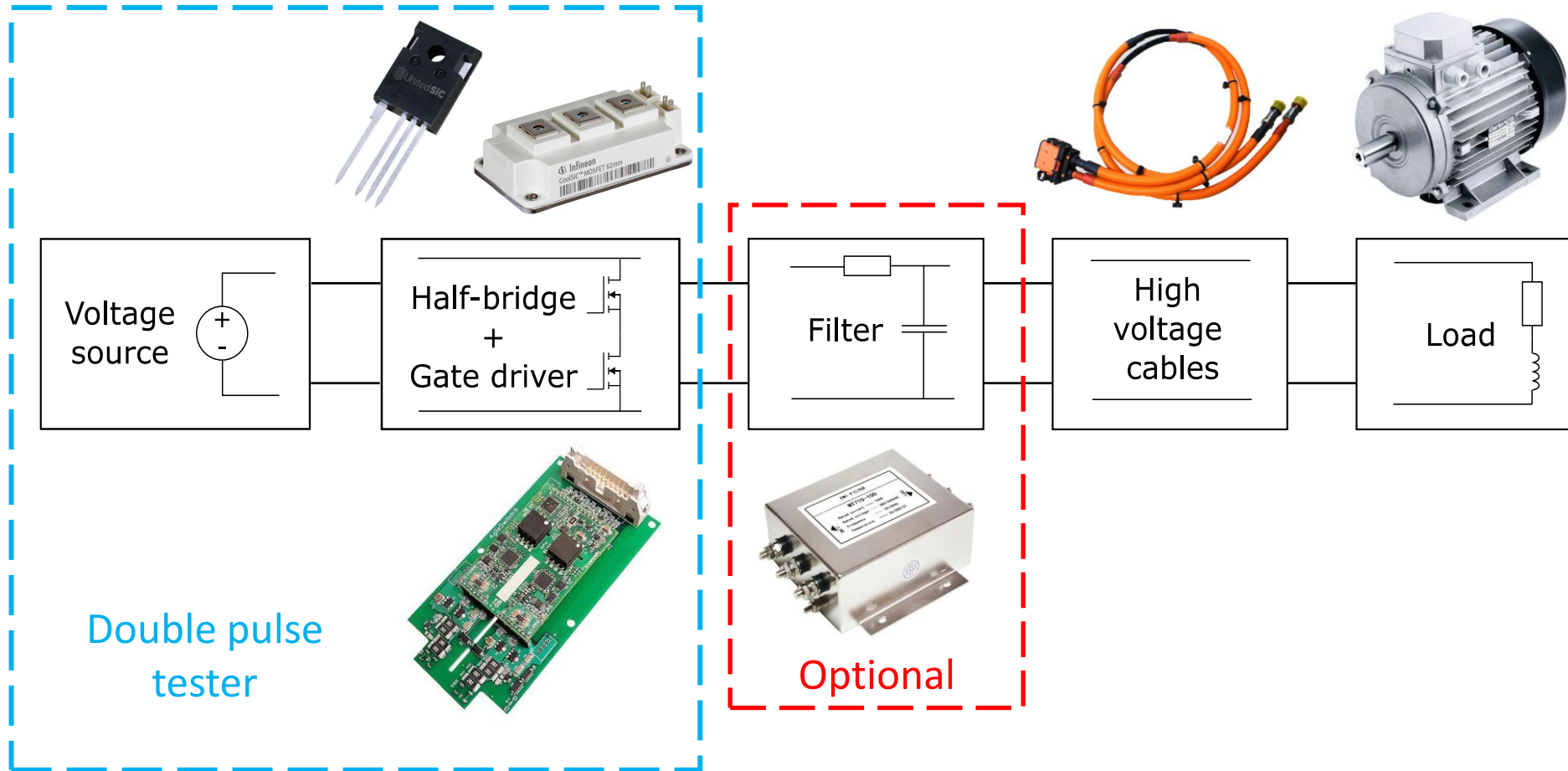
What else can the double pulse tester be used for?

Investigate how switching events effect electric insulation

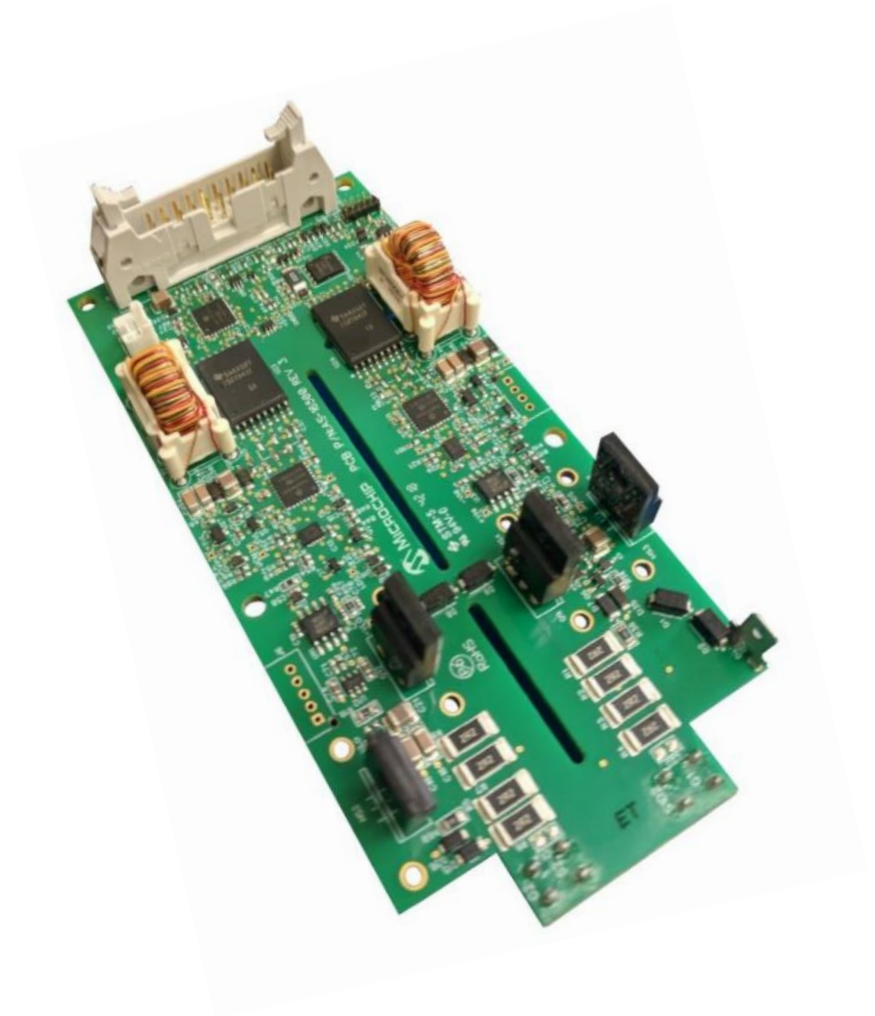
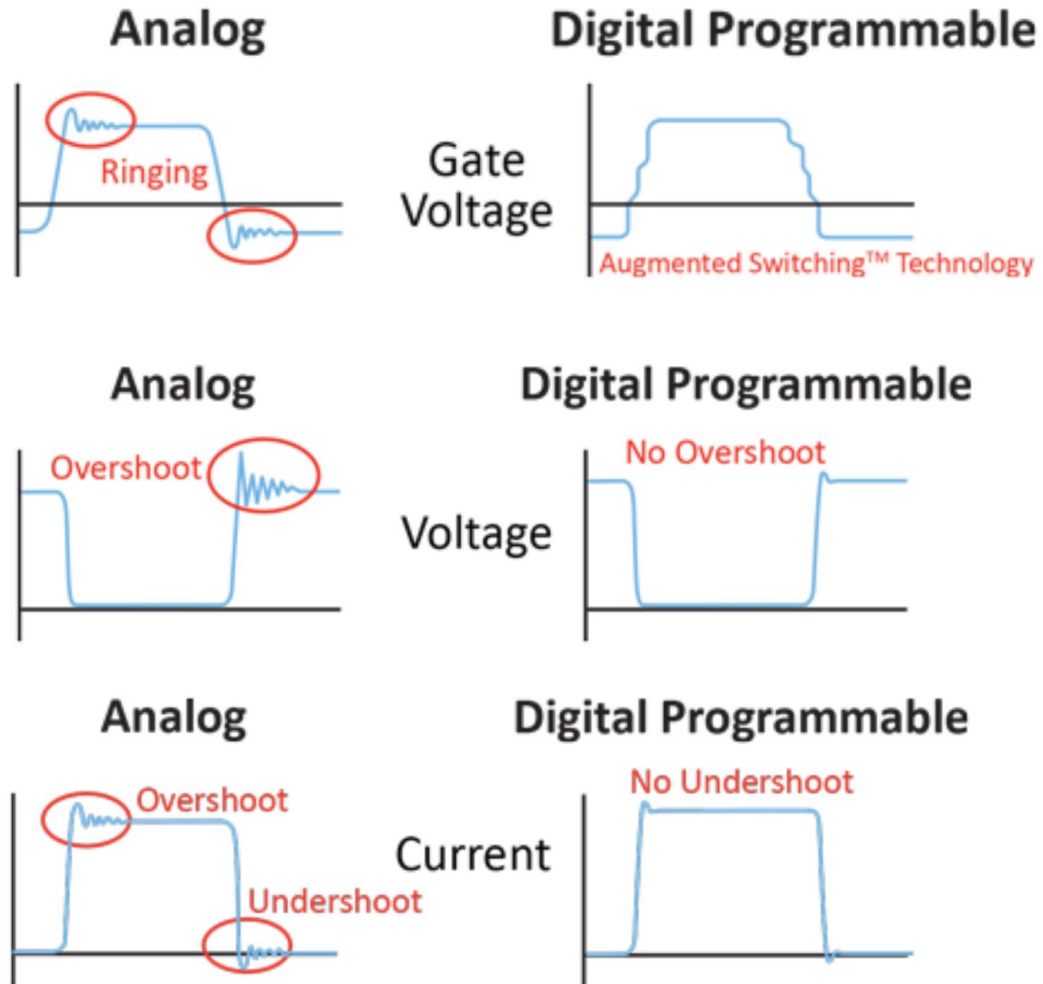
- Switching events cause high dV/dt
- High dV/dt can break down insulation in electric machines



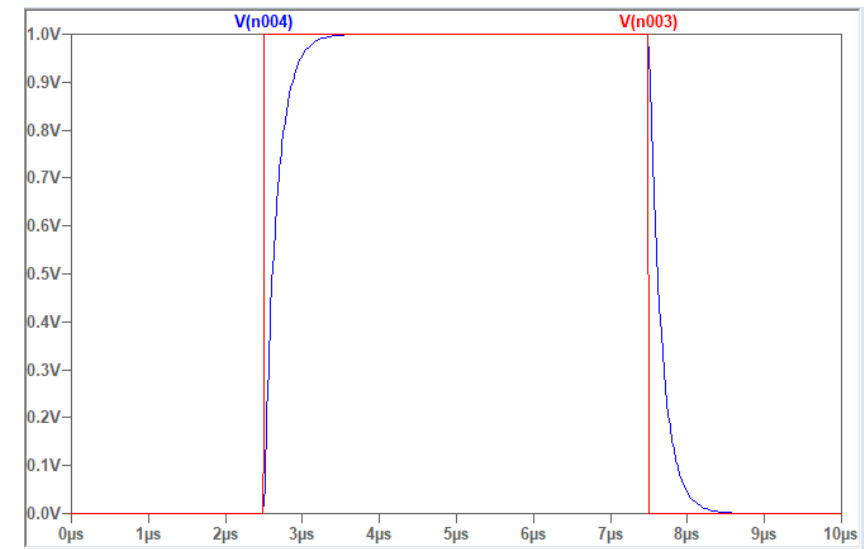
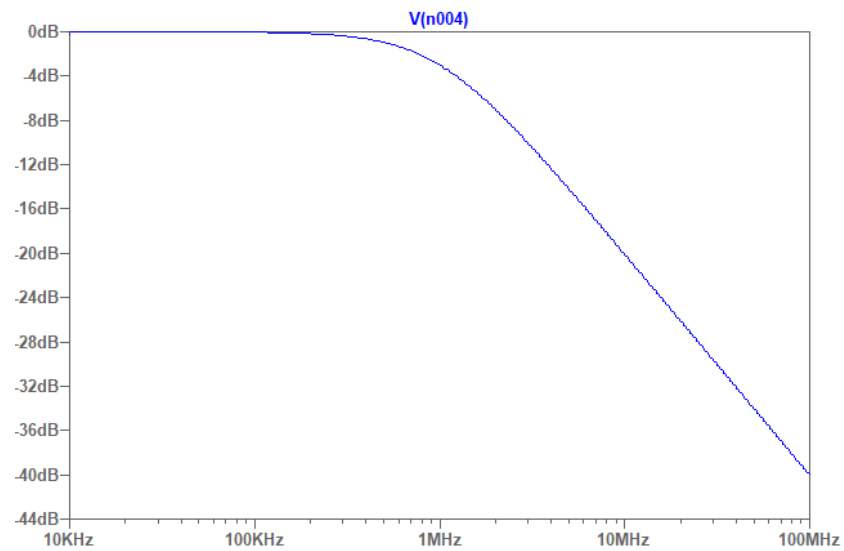
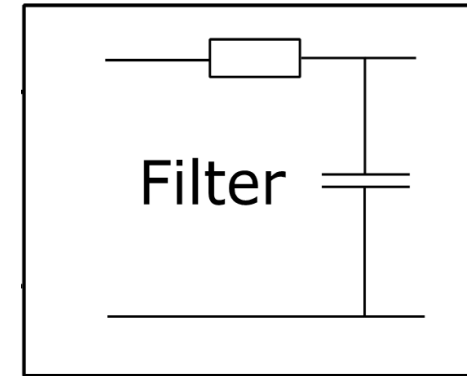
Test of electric insulation



Programmable gate driver



Filter - Reduce dV/dt



Summary

- A double pulse tester can be used to characterize power transistors
- PCB design is important for proper switching performance
- High bandwidth is needed for the measurement equipment

Questions?